Supporting Information for

## **Dopant-Tunable Ultra-Thin Transparent Conductive Oxides**

## for Efficient Energy Conversion Devices

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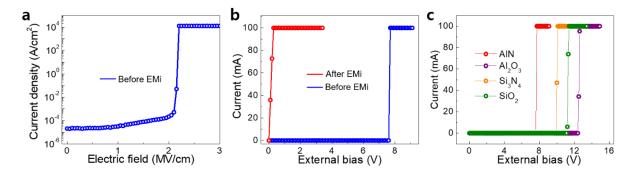
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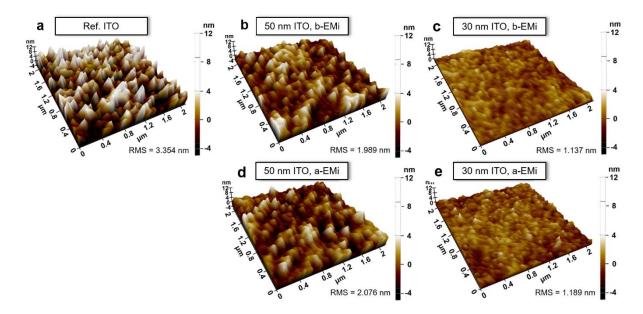
<sup>#</sup>Dae Yun Kang and Bo-Hyun Kim contributed equally to this work

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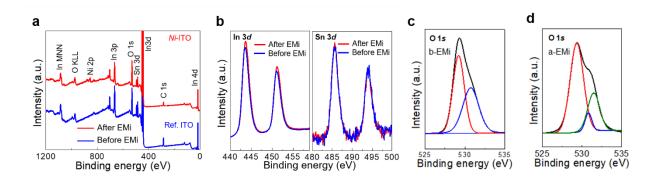
## **Supplementary Figures and Tables**



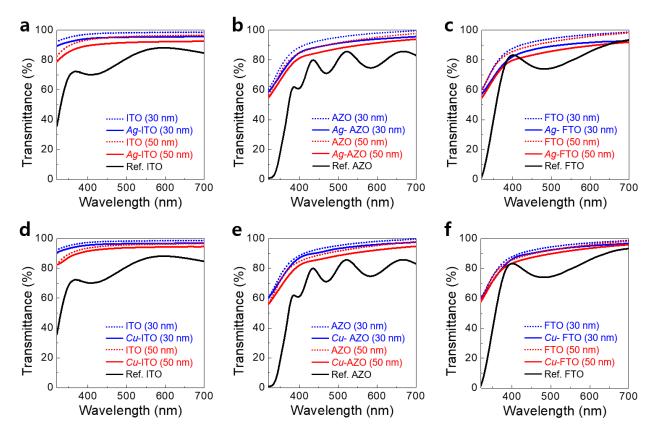
**Fig. S1 a** Current density versus electric field curve of the Ni/AlN/ITO structure during the EMi process. **b** Current versus voltage properties of the Ni/AlN/ITO structure before and after EMi. **c** Current–voltage characteristics measured for 10-nm AlN, Al<sub>2</sub>O<sub>3</sub>, Si<sub>3</sub>N<sub>4</sub>, and SiO<sub>2</sub> buffer layers during the EMi process



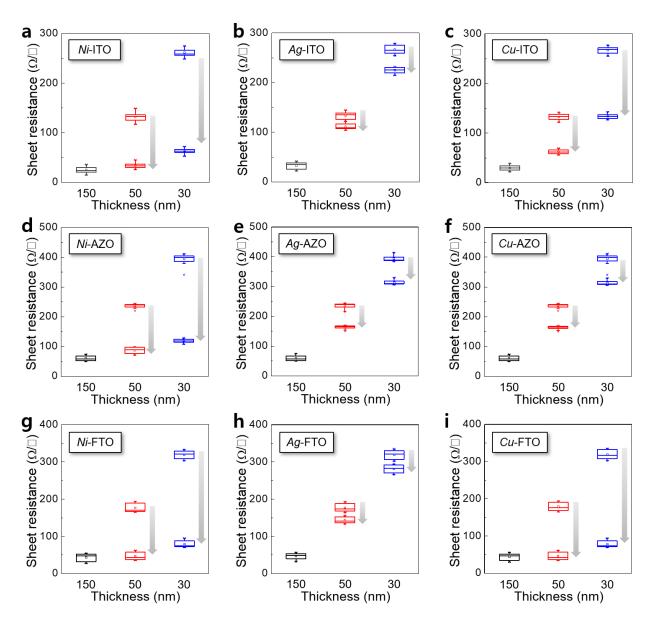
**Fig. S2** AFM surface morphologies of **a** 150-nm Ref. ITO, **b** 50- and **c** 30-nm pure ITO films before EMi (b-EMi), and **d** 50- and **e** 30-nm *Ni*-ITO films after EMi (a-EMi). The vertical scale is displayed by the color scale bar



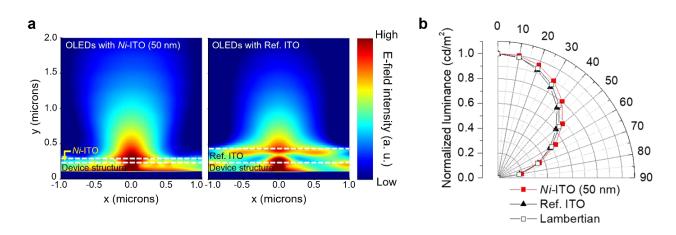
**Fig. S3** XPS spectra of ITO before and after EMi for **a** wide scan and **b** In 3*d* and Sn 3*d* core levels. XPS core-level spectra of O 1*s* **c** before *Ni*-EMi and **d** after *Ni*-EMi



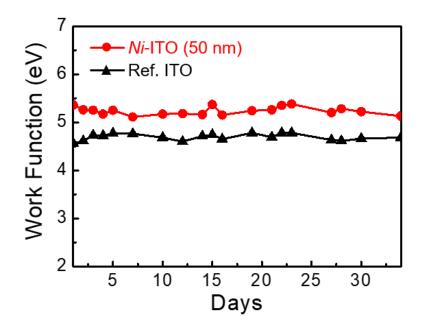
**Fig. S4** Comparison of UV–Vis transparency of ITO, AZO, and FTO, respectively, before and after EMi with **a–c** Ag and **d–f** Cu



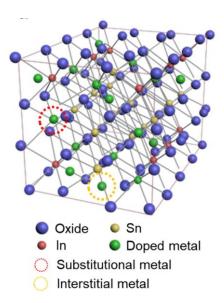
**Fig. S5** Comparison of doped metal and film-thickness-dependent sheet resistance: **a**–**c** *Ni*-, *Ag*- and *Cu*-ITO **d**–**f** *Ni*-, *Ag*- and *Cu*-AZO, and **g**–**i** *Ni*-, *Ag*- and *Cu*-FTO. The film thickness of the TCOs decreased from 150 nm to 50 and 30 nm



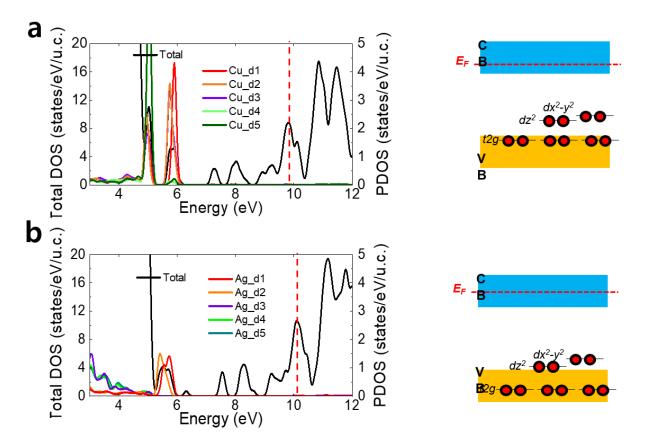
**Fig. S6 a** Near-field distribution of the OLEDs with 50-nm *Ni*-ITO (left) and 150-nm Ref. ITO (right) anodes. **b** Normalized angular-dependent luminance profiles measured at 7 V for *Ni*-ITO/OLED and Ref. ITO/OLED. The calculated Lambertian profiles are also provided for comparison



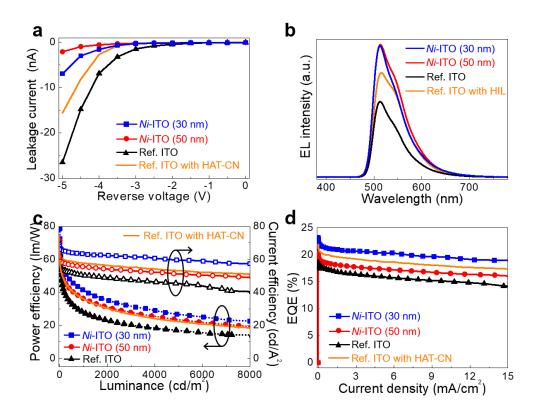
**Fig. S7** Work function changes in air over 34 days for the Ref. ITO (black triangle) and 50 nm *Ni*-ITO (red circle). In each case, the values are the averages measured from 10 different points of the film



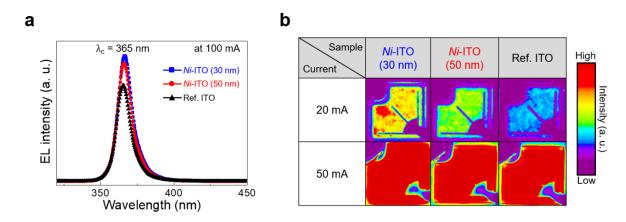
**Fig. S8** Ideal atomic structure of the *m*-ITO film with substitutional (red circle) and interstitial (yellow circle) metal impurities



**Fig. S9** Theoretical calculation: Total DOS and PDOS corresponding to **a** Cu and **b** Ag atoms (left panels) and schematics of defect levels (right panels) for interstitially positioned Cu and Ag in the ITO matrix



**Fig. S10** Leakage currents and luminescence properties (at 5,000 cd/m<sup>2</sup>) of green OLEDs (150nm Ref. ITO/OLED and 30- and 50-nm *Ni*-ITO/OLEDs) with and without hexaazatriphenylene hexacarbonitrile (HAT-CN) HIL. **a** Leakage current characteristics for each OLED. **b** EL intensity spectra versus wavelength for each OLED. **c** Power efficiency (solid symbol) and current efficiency (open symbol) versus luminance for each OLED. **d** External quantum efficiency versus current density for each OLED



**Fig. S11 a** Electroluminescence spectra as a function of wavelength measured for each sample at 100 mA. **b** Microscopic light emission photographs measured at 20 mA and 50 mA for each sample. The linear color scale is the relative intensity of the emission distribution

	Thickness	30 nm		50 nm		150 nm
Electrodes	Ni-EMi	Before	After	Before	After	Ref. TCO
	Sheet resistance, $R_{\rm SH}(\Omega/\Box)$	261 ± 15	61 ± 10	13 ± 18	34 ± 11	26 ± 11
ITO	Resistivity, $\rho$ (10 <sup>-4</sup> $\Omega$ ·cm)	7.83 ± 0.4	1.83 ± 0.3	$\begin{array}{c} 6.55 \\ \pm \ 0.9 \end{array}$	$\begin{array}{c} 1.71 \\ \pm \ 0.5 \end{array}$	3.90 ± 1.6
	Transmittance at 550 nm, T (%)	98.4 ± 0.2	96.8 ± 0.1	96.1 ± 0.3	93.9 ± 0.1	86.7 ± 0.3
AZO	Sheet resistance, $R_{\rm SH}(\Omega/\Box)$	398 ± 17	151 ± 12	228 ± 15	87 ± 18	61 ± 13
	Resistivity, $\rho$ (10 <sup>-4</sup> $\Omega$ ·cm)	11.94 ± 0.5	$4.53 \pm 0.3$	$11.40 \pm 0.7$	$4.35\pm0.8$	9.15 ± 1.9
	Transmittance, T at 550 nm (%)	96.9 ± 0.3	$95.5 \pm 0.1$	93.6 ± 0.3	91.5 ± 0.1	79.7 ± 0.5
FTO	Sheet resistance, $R_{\rm SH}(\Omega/\Box)$	317 ± 17	81 ± 14	177 <u>±</u> 18	47 <u>±</u> 15	$42 \pm 14$
	Resistivity, $\rho$ (10 <sup>-4</sup> $\Omega$ ·cm)	$9.51 \pm 0.4$	$2.43 \pm 0.3$	$8.85 \pm 0.8$	$2.35\pm0.7$	$6.30 \pm 2.1$
	Transmittance, T at 550 nm (%)	96.0 ± 0.3	$93.5 \pm 0.3$	94.3 ± 0.2	90.9 ± 0.1	$79.5 \pm 0.4$

<b>Table S1</b> Sheet resistance ( $R_{SH}$ ), resistivity ( $\rho$ ), and transmittance (T) of ITO, AZO, and FTO
films after Ni-EMi process. In each case, the values are averages measured from 10 specimens

Table S2 Carrier density and hole mobility of ITO, AZO, and FTO films after the Ni-EMi process

	Thickness	30 nm		50 nm		150 nm
Electrode	Ni-EMi	Before	After	Before	After	Ref. TCO
ΙΤΟ	Carrier density (10 <sup>21</sup> cm <sup>3</sup> )	$\begin{array}{c} 0.649 \\ \pm \ 0.04 \end{array}$	$\begin{array}{c} 1.311 \\ \pm \ 0.08 \end{array}$	0.693 ± 0.11	$\begin{array}{c} 1.319 \\ \pm  0.16 \end{array}$	$\begin{array}{c} 0.871 \\ \pm \ 0.18 \end{array}$
	Mobility (cm <sup>2</sup> /V·s)	11.8 ± 1.2	26.1 ± 2.3	13.8 ± 2.7	27.9 ± 2.6	18.4 ± 2.1
170	Carrier density (10 <sup>21</sup> cm <sup>3</sup> )	$\begin{array}{c} 0.51 \\ \pm \ 0.04 \end{array}$	$\begin{array}{c} 0.899 \\ \pm \ 0.03 \end{array}$	$\begin{array}{c} 0.538 \\ \pm \ 0.04 \end{array}$	$\begin{array}{c} 1.109 \\ \pm \ 0.03 \end{array}$	$\begin{array}{c} 0.558 \\ \pm \ 0.04 \end{array}$
AZO	Mobility (cm <sup>2</sup> /V·s)	10.3 ± 1.1	15.3 ± 1.3	10.2 ± 1.5	13.0 ± 1.7	12.24 ± 1.9
FTO	Carrier density (10 <sup>21</sup> cm <sup>3</sup> )	$\begin{array}{c} 0.555 \\ \pm \ 0.03 \end{array}$	$\begin{array}{c} 1.137 \\ \pm \ 0.08 \end{array}$	$\begin{array}{c} 0.587 \\ \pm \ 0.05 \end{array}$	$\begin{array}{c} 1.311 \\ \pm \ 0.13 \end{array}$	0.693 ± 0.17
	Mobility (cm <sup>2</sup> /V·s)	$\begin{array}{c} 11.8 \\ \pm 1.1 \end{array}$	$\begin{array}{c} 22.6 \\ \pm \ 0.3 \end{array}$	12.0 ± 0.2	$\begin{array}{c} 20.3 \\ \pm \ 0.1 \end{array}$	14.3 ± 0.4

**Table S3** Work function values of 30-, 50- (before EMi), and 150-nm Ref. ITO, AZO, and FTO films, and Ni-implanted (after EMi) 30- and 50-nm ITO, AZO, and FTO films. Empty cells indicate no measurement for the corresponding films. The values are the averages measured from three different specimens for the UV photoelectron spectroscopy (UPS), and 10 different points (for 3 samples) for the KP, respectively.

Electrodes		Work function (eV)					
		UI	UPS		Kelvin probe in air		
		Before EMi	After EMi	Before EMi	After EMi		
	30 nm	$4.77 \pm 0.03$	$5.09 \pm 0.04$	$4.61\pm0.02$	$5.04 \pm 0.03$		
ITO	50 nm	$4.79 \pm 0.02$	$5.27 \pm 0.03$	$4.64\pm0.04$	$5.17 \pm 0.10$		
	Ref. (150 nm)	$4.82 \pm 0.03$		$4.67\pm0.05$			
	30 nm	$4.58\pm0.03$	$5.04 \pm 0.03$	$4.69 \pm 0.03$	$5.15 \pm 0.03$		
AZO	50 nm	$4.60\pm0.01$	$5.16\pm0.05$	$4.70\pm0.08$	$5.26 \pm 0.05$		
	Ref. (150 nm)	$4.65 \pm 0.02$		$4.72\pm0.05$			
FTO	30 nm			$4.81 \pm 0.04$	$5.17 \pm 0.03$		
	50 nm			$4.89 \pm 0.02$	$5.31 \pm 0.05$		
	Ref. (150 nm)			$4.91 \pm 0.03$			

**Table S4** Device performance of OLEDs including the driving voltage  $(V_D)$ , current efficiency (CE), power efficiency (PE), and external quantum efficiency (EQE). In each case, the values are the averages measured from 10 different specimens

Sample name	HIL (HAT- CN)	$ transform{     V_{\rm D} \\ at 1000 \text{ cd/m}^2 \\ (V) $	CE at 1000 cd/m <sup>2</sup> (cd/A)	PE at 1000 cd/m <sup>2</sup> (lm/W)	Max. EQE (%)
<i>Ni</i> -ITO (30 nm)		$4.83 \pm 0.1$ (15.3%)	$63.5 \pm 1.2$ (26.2%)	41.3 ± 0.7 (49.1%↑)	23.2 ± 0.3 (24.7%↑)
Ni-ITO (50 nm)	Without HIL	$4.81 \pm 0.1$ (15.6%)	55.2 ± 1.3 (9.7%↑)	$35.9 \pm 0.9$ (29.6% $\uparrow$ )	$20.3 \pm 0.2$ (9.1% $\uparrow$ )
Ref. ITO (150 nm)		$5.7 \pm 0.1$	50.3 ± 1.1	$27.7 \pm 1.0$	18.6 ± 0.4
Ref. ITO (150 nm)	With HIL	$5.05 \pm 0.13$ (11.4%)	$60.1 \pm 1.5$ (19.5% $\uparrow$ )	$39.5 \pm 1.2$ (42.6% $\uparrow$ )	$22.0 \pm 0.3$ (18.3% $\uparrow$ )

**Table S5** Device performance of 365-nm UV LEDs including the forward voltage ( $V_{\rm F}$ ), reverse leakage current ( $I_{\rm L}$ ), and light output power ( $P_{\rm O}$ ). In each case, the values are the averages measured from 10 different specimens

Sample name	V <sub>F</sub> at 20 mA (V)	<i>I</i> <sub>L</sub> at 5 V (nA)	<i>P</i> <sub>O</sub> at 100 mA (a.u.)
<i>Ni</i> -ITO (50 nm)	4.85 ± 0.1 (12%↓)	-19.2 ± 2.6 (51%↓)	53.4 ± 1.1 (23%↑)
<i>Ni</i> -ITO (30 nm)	$5.0 \pm 0.1 \ (9\%\downarrow)$	-27.6 ± 3.1 (30%↓)	56.7 ± 1.3 (31%↑)
Ref. ITO (150 nm)	$5.5 \pm 0.1$	-39.4 ± 3.3	43.3 ± 1.7

**Table S6** Device performance of OPVs including the open-circuit voltage ( $V_{OC}$ ), short-circuit current ( $J_{SC}$ ), fill factor (FF) and power conversion efficiency (PCE). In each case, the values are the averages measured from 10 different specimens

Sample Name	V <sub>OC</sub> (mV)	J <sub>SC</sub> (μA cm <sup>-2</sup> )	FF (%)	PCE (%)
<i>Ag</i> -ITO (30 nm)	$611\pm3$	96.1 ± 1.1	$65.8 \pm 1.3$	$13.8\pm0.3$
<i>Ag</i> -ITO (50 nm)	$605\pm1$	92.7 ± 2.2	$61.3 \pm 1.6$	$12.1\pm0.2$
Pure ITO (30 nm)	$499 \pm 11$	$69.9\pm0.5$	$34.0\pm2.7$	$4.2\pm0.7$
Pure ITO (50 nm)	$450 \pm 13$	$75.2\pm0.7$	38.1 ± 2.4	$4.8\pm0.5$
Ref. ITO (150 nm)	$592 \pm 1$	$89.5\pm2.9$	$60.2\pm0.5$	$11.4\pm0.5$